

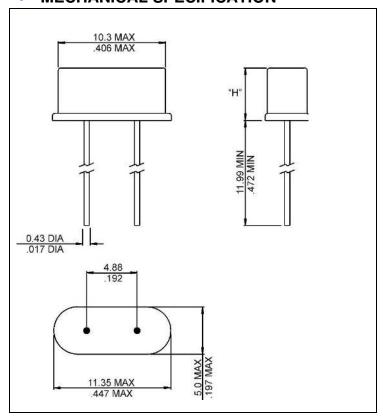
AS-25.000-18-F-TR

SPECIFICATIONS

PARAMETER	VALUE	
NOMINAL FREQUENCY	25.000 MHz	
MODE OF OSCILLATION	Fundamental	
FREQUENCY TOLERANCE AT 25°C	±30 ppm max	
FREQUENCY STABILITY OVER TEMPERATURE	±50 ppm max	
OPERATING TEMPERATURE RANGE	-20°C to +70°C	
STORAGE TEMPERATURE RANGE	-55°C to +125°C	
AGING	±5 ppm per year max	
LOAD CAPACITANCE	18 pF	
EQUIVALENT SERIES RESISTANCE	30 Ω max	
SHUNT CAPACITANCE	6 pF max	
DRIVE LEVEL	100 μW typ, 500 μW max	
REFLOW CONDITIONS	260°C for 10s max	
INSULATION RESIATANCE	500 MΩ min @ DC 100V	



MECHANICAL SPECIFICATION



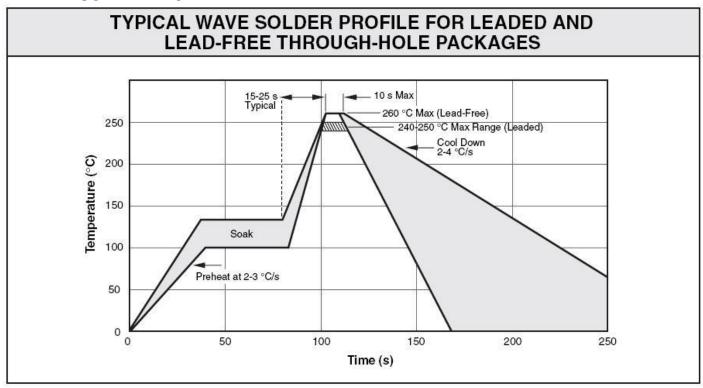
H=3.5 mm





AS-25.000-18-F-TR

WAVE SOLDER PROFILE



Wave Solder profile				
Profile Feature	SnPb eutectic	Pb-Free		
Average ramp-up rate	~200°C/second	~200°C/second		
Heating Rate during preheat	typical 1-2°/second max 4°/second	typical 1-2°/second max 4°/second		
Final preheat temperature, T _S	~130°C	~130°C		
Peak temperature, T _P	235°C	260°C		
Time within +0°C / -5°C of actual temperature, tP	10 seconds	10 seconds		
Ramp-down rate	5°C/second max.	5°C/second max.		

NOTE: This document should serve as recommendation only. Other parameters may also affect soldering, this profile does not guarantee absolute success. Soldering profile should be determined by the equipment manufacturer and customers' process engineer.

ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
RoHS	Compliant
REACH SVHC	Compliant
HALOGEN-FREE	Compliant
ESD CLASSIFICATION LEVEL	N/A
TERMINATION FINISH	Sn





LOW PROFILE MICROPROCESSOR CRYSTAL

Page 3 of 3

AS-25.000-18-F-TR

MARKING

R250xByw

x − 1 or 2 digits as Internal Production ID code

y – Year code

w – Week code

YEAR CODE		
Year	Code	
2015	5	
2016	6	
2017	7	
2018	8	
2019	9	
2020	0	
2021	1	
2022	2	
2023	3	
2024	4	
2025	5	

	ALPHA WEEK CODE TABLE				
Week	Code	Week	Code	Week	Code
1	a	19	s	37	K
2	b	20	t	38	L
3	c	21	u	39	M
4	d	22	v	40	N
5	e	23	w	41	О
6	f	24	x	42	P
7	g	25	y	43	Q
8	h	26	z	44	R
9	i	27	A	45	S
10	j	28	В	46	T
11	k	29	C	47	U
12	1	30	D	48	V
13	m	31	E	49	W
14	n	32	F	50	X
15	o	33	G	51	Y
16	p	34	Н	52	Z
17	q	35	I		
18	r	36	J		

APPROVAL

DRAWN BY:	A, Initial Release, August 23, 2012
APPROVED BY:	A, Initial Release, August 23, 2012
REVISION:	B, Updated to current spec levels
	by YI i. May 7, 2020

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